

Title (en)  
IMPLANTABLE DEVICES AND METHODS OF FORMING THE SAME

Title (de)  
IMPLANTIERBARE PRODUKTE UND VERFAHREN ZU IHRER BILDUNG

Title (fr)  
DISPOSITIFS IMPLANTABLES, ET LEURS PROCÉDÉS DE FORMATION

Publication  
**EP 2077797 A2 20090715 (EN)**

Application  
**EP 07814498 A 20070828**

Priority

- US 2007076960 W 20070828
- US 82369206 P 20060828
- US 82543406 P 20060913
- US 61344306 A 20061220
- US 89592407 P 20070320
- US 94181307 P 20070604
- US 84337607 A 20070822

Abstract (en)  
[origin: WO2008027871A2] An implantable device and method of forming the same comprises a substrate, an adhesion layer, and a capping layer. The adhesion layer comprises a portion with a predominant proportion of palladium, the portion of the predominant proportion of palladium directly on the substrate. The capping layer comprises a capping layer material, and is on the adhesion layer.

IPC 8 full level  
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